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PATENT

Attorney Docket No.: SAM-0298

## THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Jae-Hak Kim, *et al.*

Examiner: Rao, S. H.

Serial No.: 09/994,508

Group Art Unit: 2814

Filing Date: November 27, 2001

Title: METHOD OF FABRICATING SEMICONDUCTOR DEVICES HAVING LOW  
DIELECTRIC INTERLAYER INSULATION LAYER

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CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8

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AMENDMENT B

Sir:

The following is in response to the Office Action dated September 15, 2004, and is filed within the shortened statutory period of three months. Please amend the application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 7 of this paper.